

EMM5078ZV

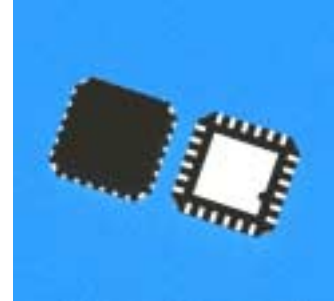
C-Band Power Amplifier MMIC

FEATURES

- Output Power; P1dB = 26 dBm (Typ.)
- High Gain; GL = 30 dB(Typ.)
- Wide Frequency Band ; 3.4 – 8.5 GHz
- Impedance Matched Zin/Zout = 50Ω
- QFN 24pin Plastic Mold Package(ZV)

DESCRIPTION

The EMM5078ZV is a wide band power amplifier MMIC that contains a three stage amplifier, internally matched, for standard communications band in 3.4 to 8.5GHz frequency range. Eudyna's stringent Quality Assurance Program assures the highest reliability and consistent performance.



ABSOLUTE MAXIMUM RATING

Item	Symbol	Rating	Unit
Drain-Source Voltage	V _{DD}	10	V
Gate-Source Voltage	V _{GG}	-3	V
Input Power	P _{in}	22	dBm
Storage Temperature	T _{stg}	-55 to +125	°C

RECOMMENDED OPERATING CONDITIONS

Item	Symbol	Condition	Unit
Drain-Source Voltage	V _{DD}	<=6	V
Input Power	P _{in}	<=2	dBm
Operating Backside Temperature	Top	-40 to +85	°C

ELECTRICAL CHARACTERISTICS (Case Temperature Tc=25°C)

Item	Symbol	Test Conditions	Limits			Unit
			Min.	Typ.	Max.	
Frequency Range	f	V _{DD} =6V	3.4	-	8.5	GHz
Output Power at 1dB G.C.P.	P _{1dB}	I _{DD} (DC)=300mA typ.	23	26	-	dBm
Power Gain at 1dB G.C.P.	G _{1dB}	Zs=Zl=50ohm	24	29	-	dB
Power-added Efficiency at 1dB G.C.P.	η _{add}		-	18	-	%
Third Order Intermodulation*	IM ₃	*:Δf=10MHz ,	-35	-40	-	dBc
Drain Current at 1dB G.C.P.	IDD	2-Tone Test,	-	350	450	mA
Input Return Loss (at Pin=-20dBm)	RL _{in}	Pout=15dBm S.C.L.	-	-10	-	dB
Output Return Loss (at Pin=-20dBm)	RL _{out}		-	-10	-	dB

G.C.P.:Gain Compression Point, S.C.L.:Single Carrier Level

ESD	Class 0	~ 250V
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Note : Based on JEDEC JESD22-A114C

CASE STYLE	ZV
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MSL	3
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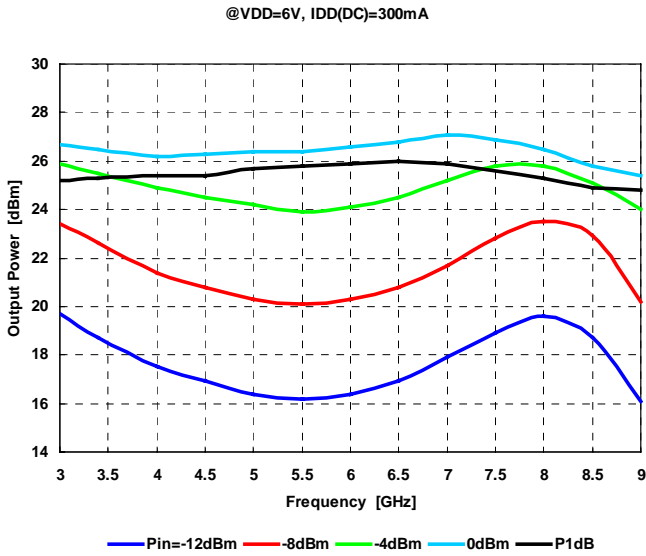
Note : Based on IPC/JEDEC J-STD-020C

RoHs Compliance	Yes
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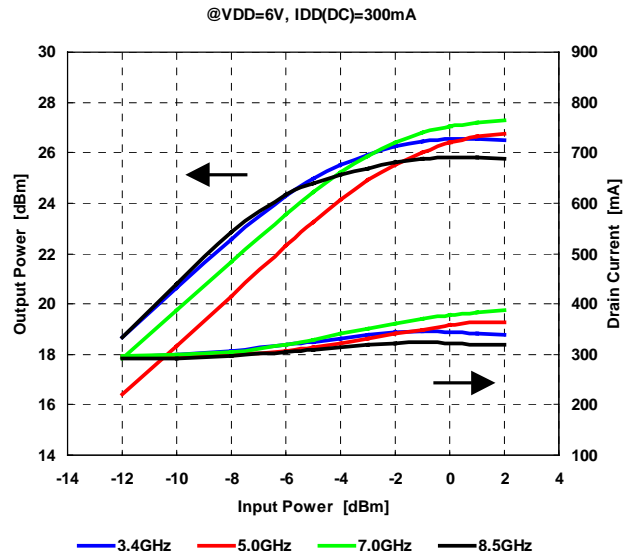
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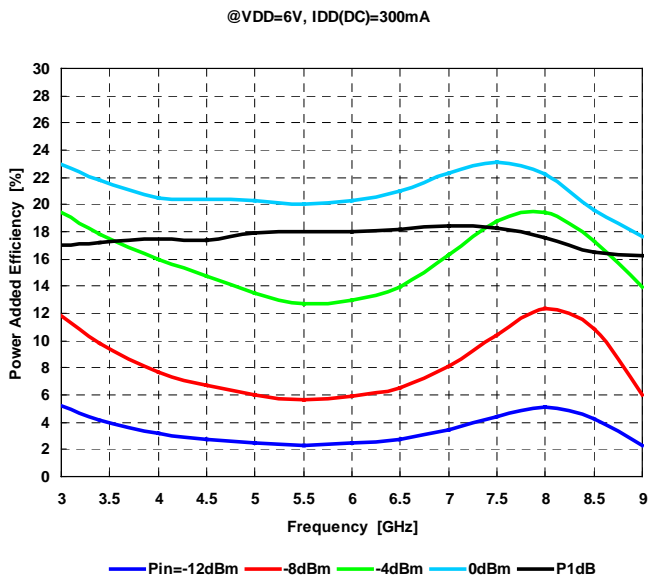
Output Power vs. Frequency



Output Power, Drain Current vs. Input Power



Power Added Efficiency vs. Frequency



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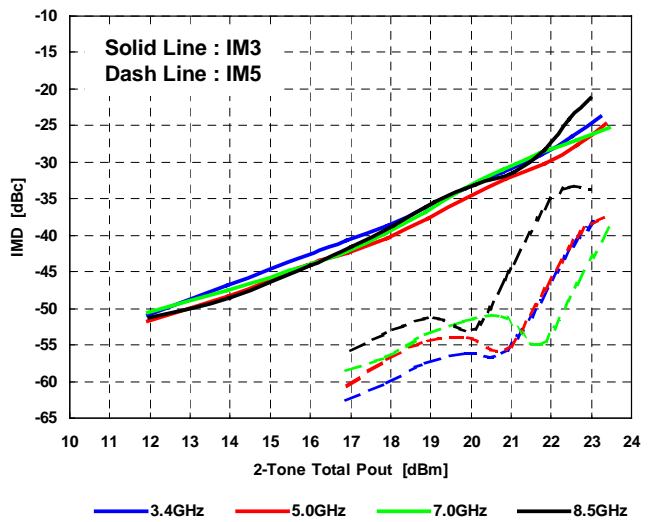
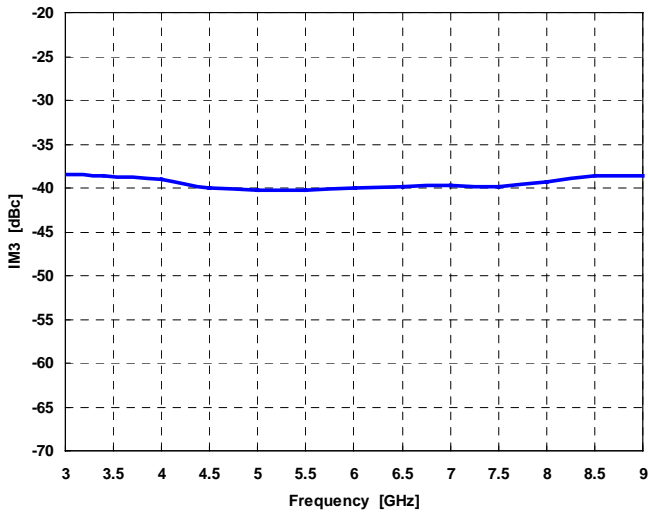
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IM3 vs. Frequency

IMD vs. Output Power

@VDD=6V, IDD(DC)=300mA, @Po=15dBm S.C.L.

@VDD=6V, IDD(DC)=300mA

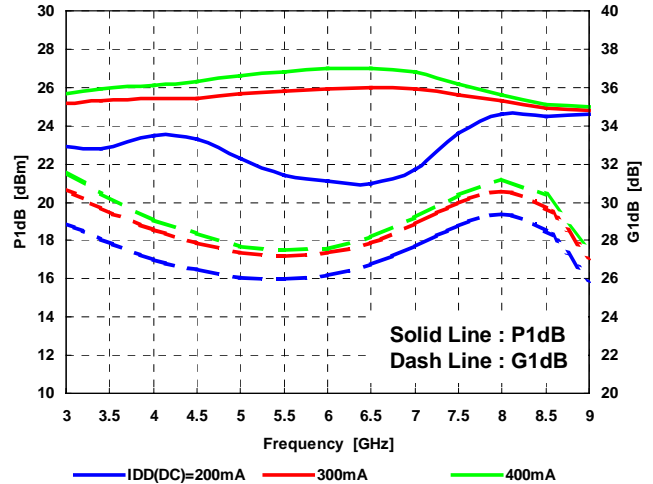
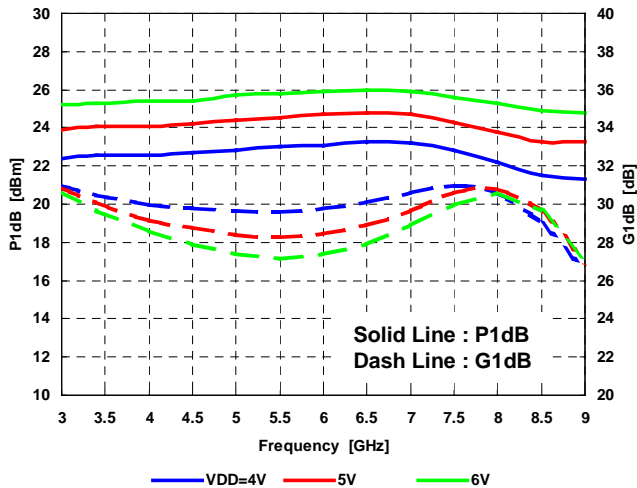


P1dB, G1dB vs. Frequency by Drain Voltage

P1dB, G1dB vs. Frequency by Drain Current

@IDD(DC)=300mA

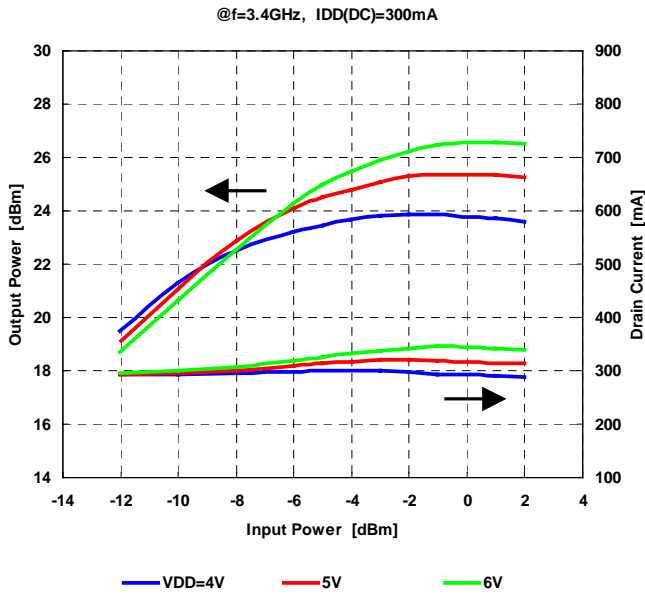
@VDD=6V



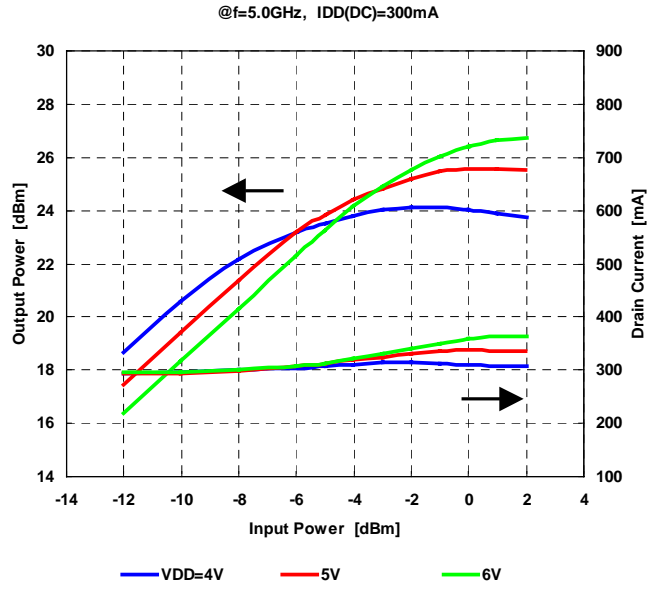
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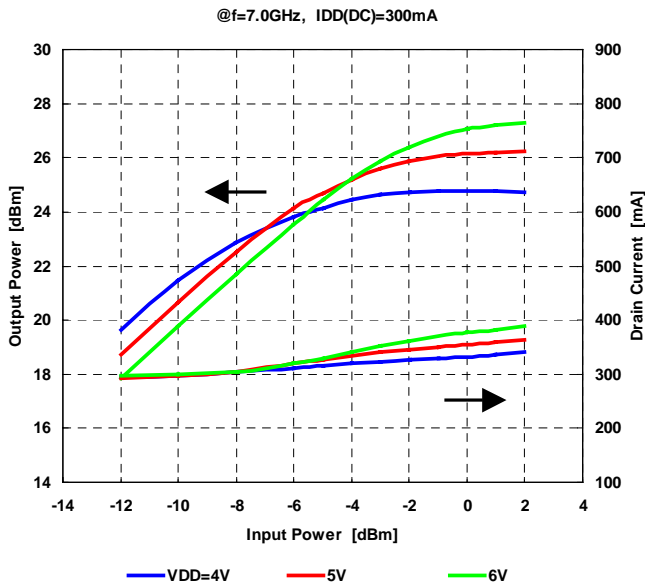
Output Power, Drain Current vs. Input Power by Drain Voltage



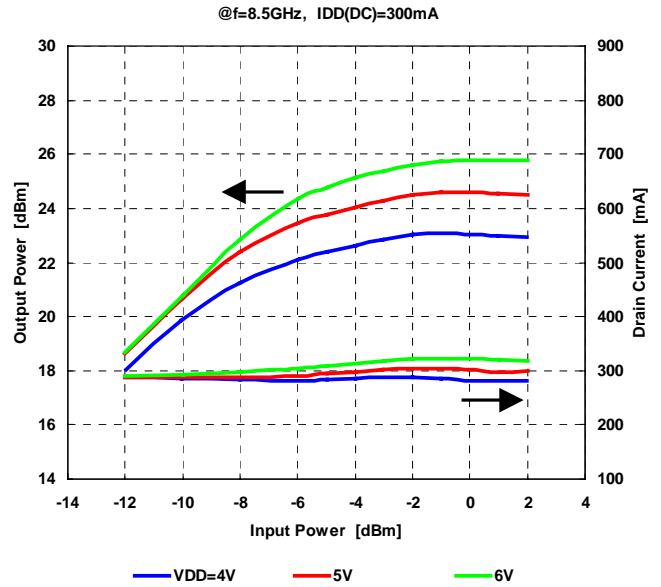
Output Power, Drain Current vs. Input Power by Drain Voltage



Output Power, Drain Current vs. Input Power by Drain Voltage



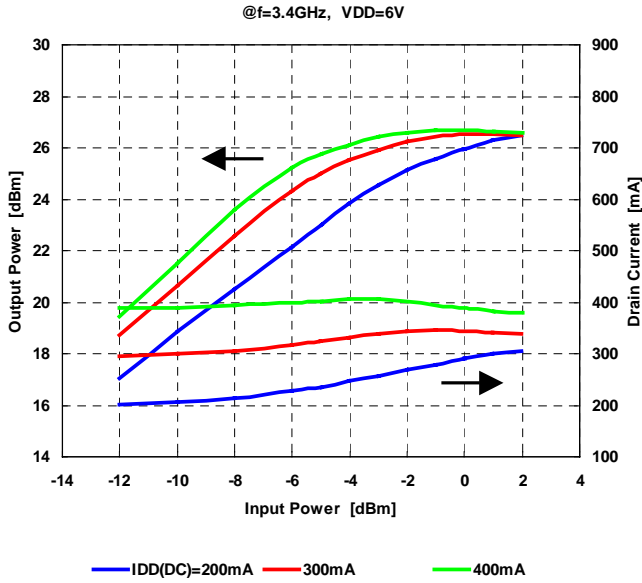
Output Power, Drain Current vs. Input Power by Drain Voltage



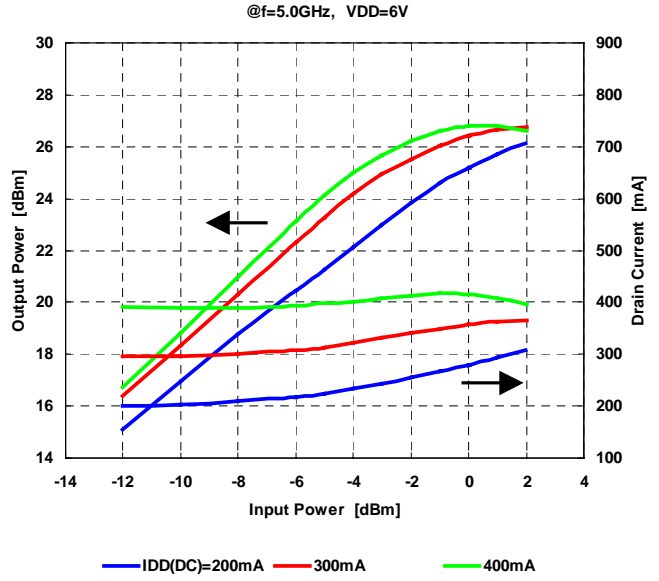
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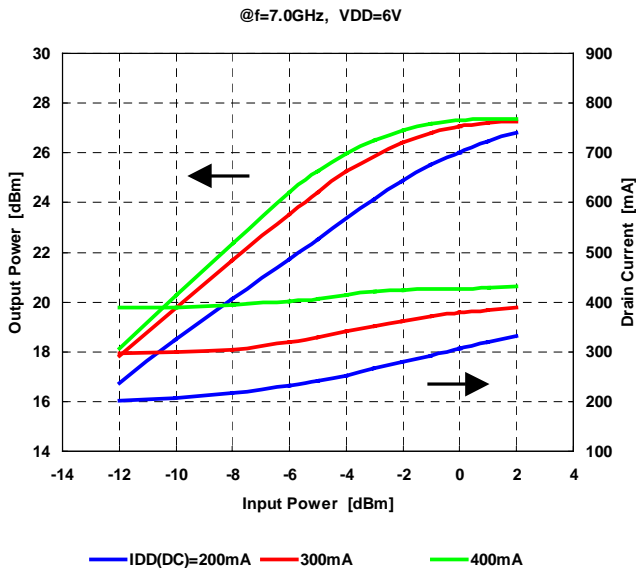
Output Power, Drain Current vs. Input Power by Drain Current



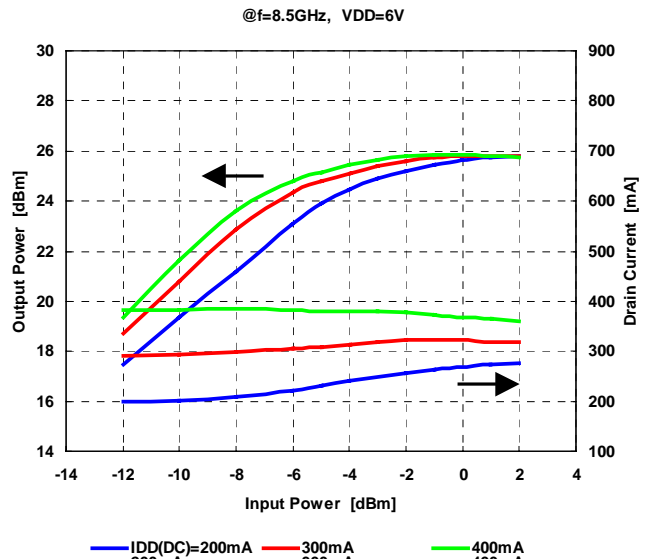
Output Power, Drain Current vs. Input Power by Drain Current



Output Power, Drain Current vs. Input Power by Drain Current



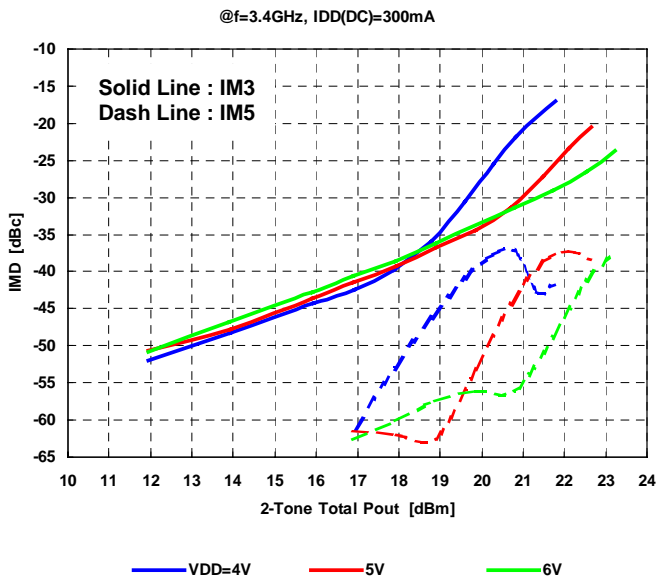
Output Power, Drain Current vs. Input Power by Drain Current



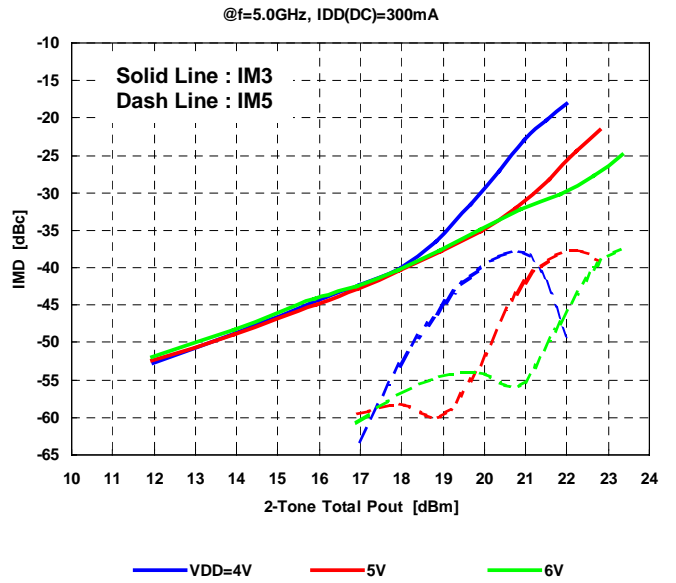
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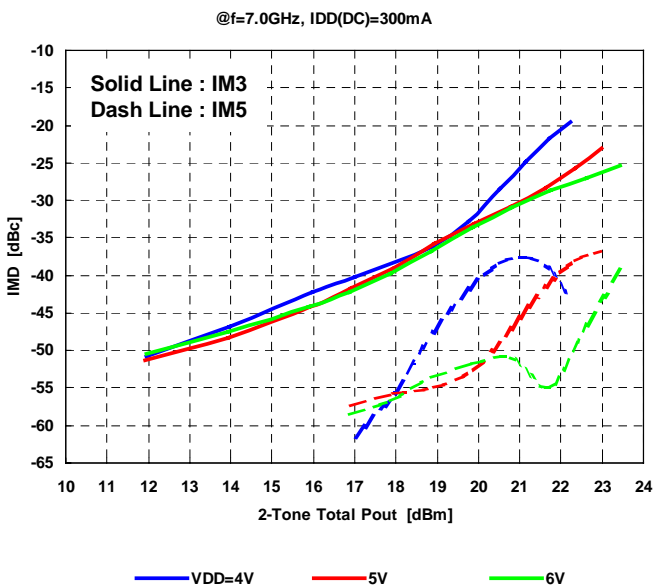
IMD vs. Output Power by Drain Voltage



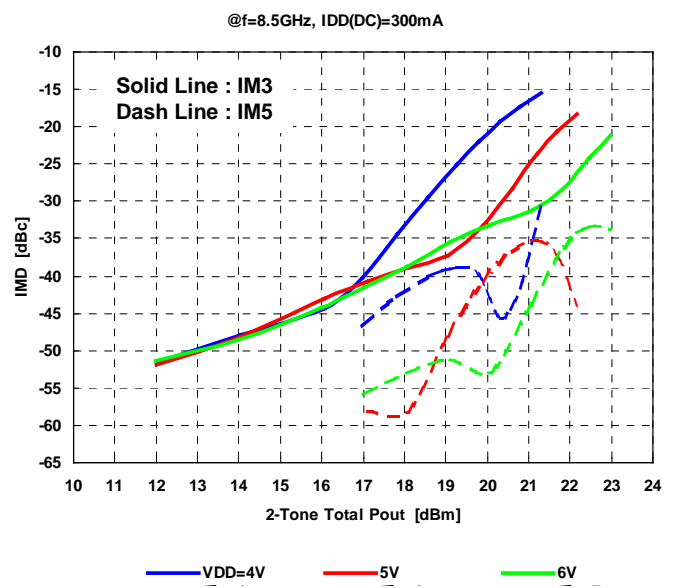
IMD vs. Output Power by Drain Voltage



IMD vs. Output Power by Drain Voltage



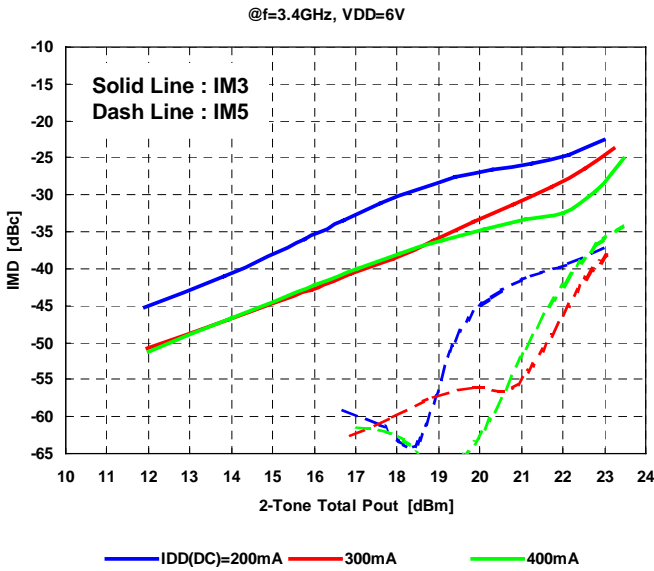
IMD vs. Output Power by Drain Voltage



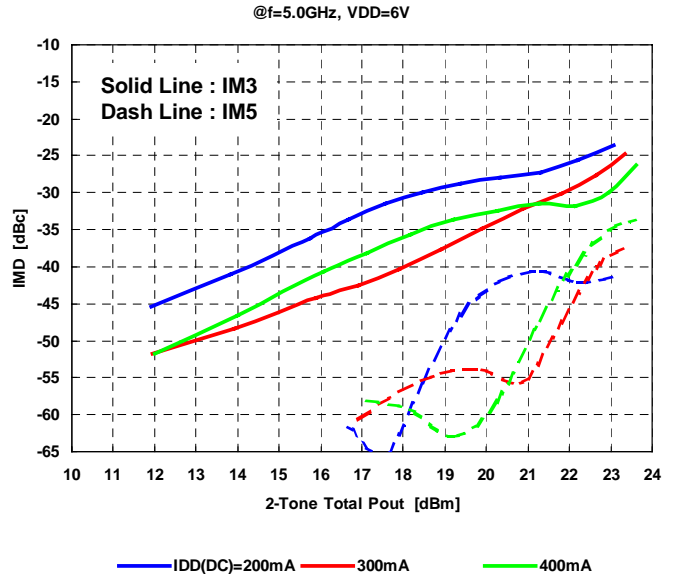
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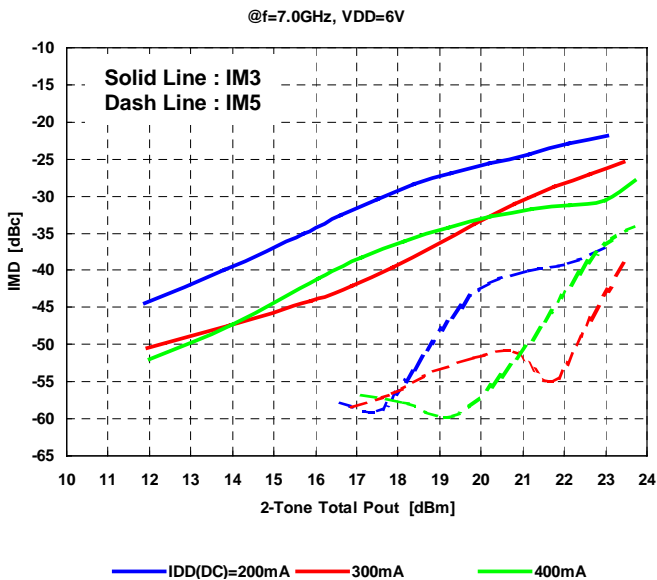
IMD vs. Output Power by Drain Current



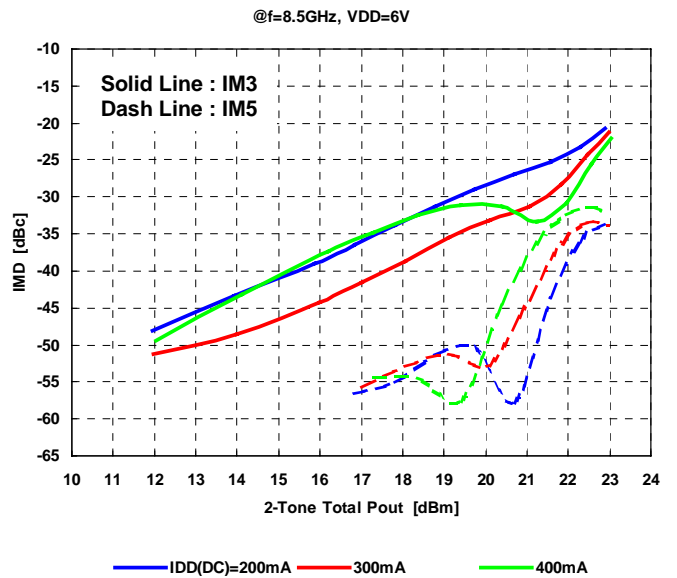
IMD vs. Output Power by Drain Current



IMD vs. Output Power by Drain Current



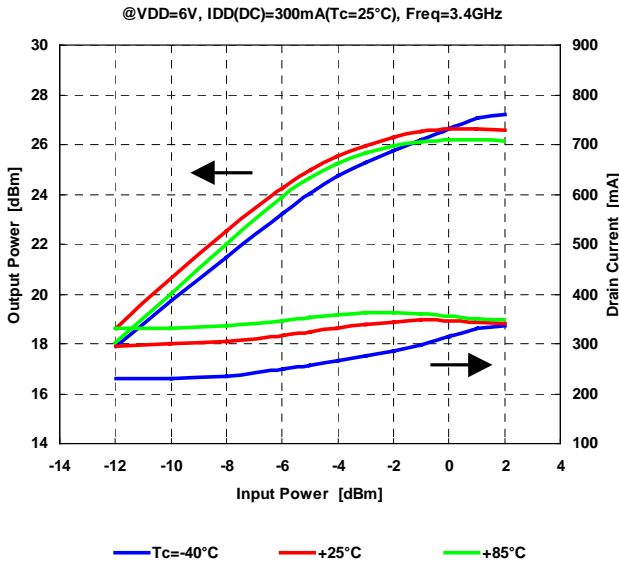
IMD vs. Output Power by Drain Current



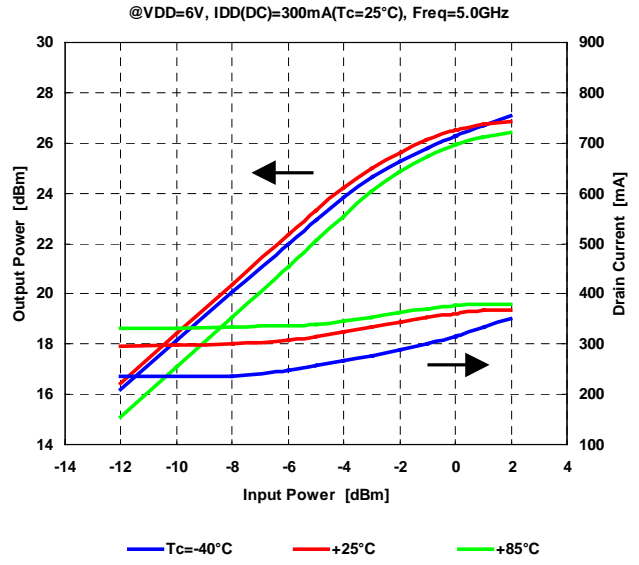
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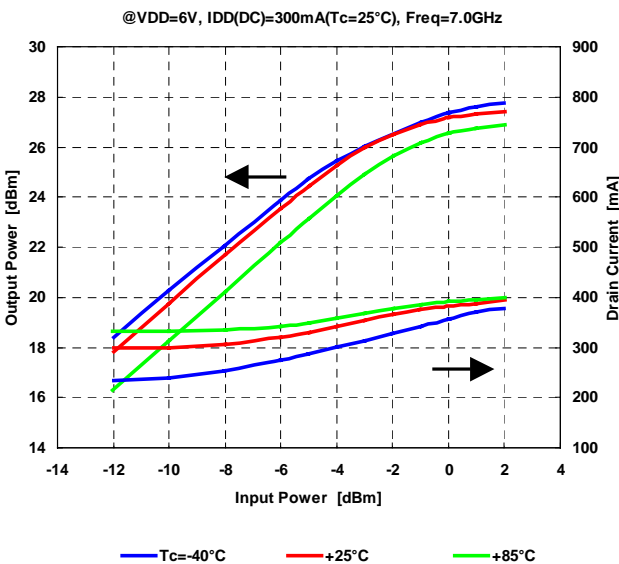
Output Power, Drain Current vs. Input Power by Temperature



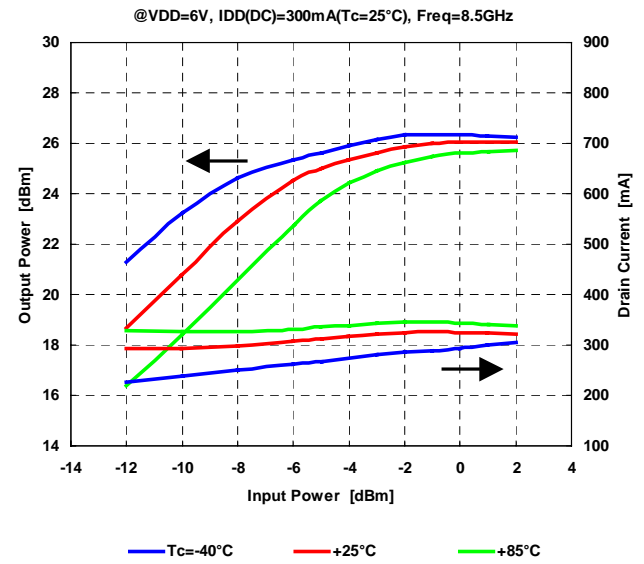
Output Power, Drain Current vs. Input Power by Temperature



Output Power, Drain Current vs. Input Power by Temperature



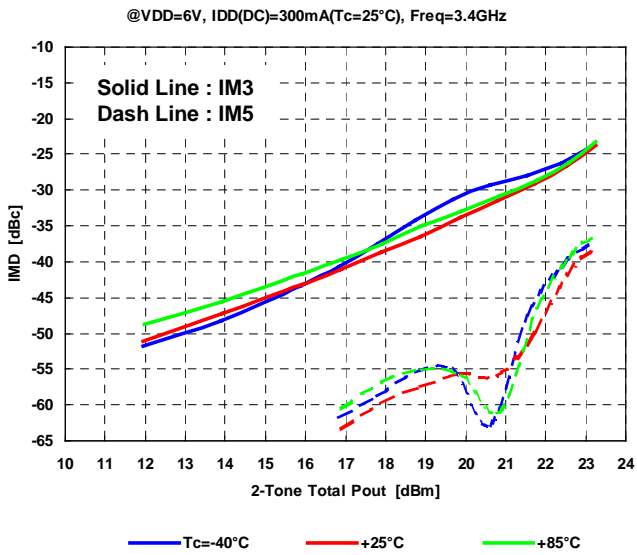
Output Power, Drain Current vs. Input Power by Temperature



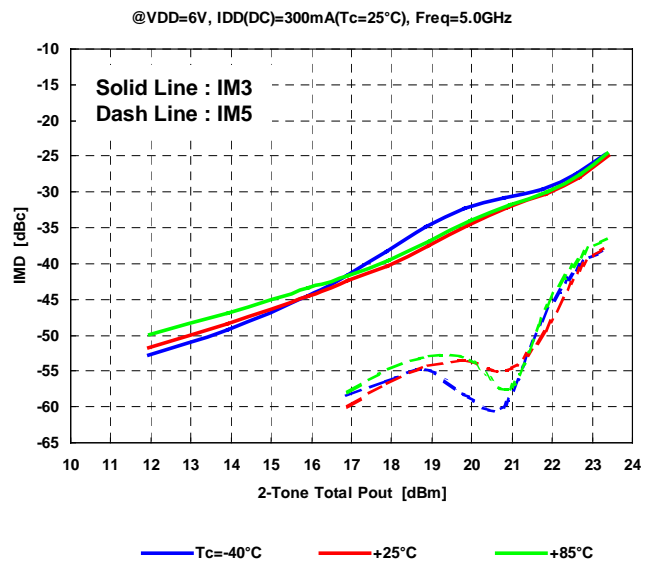
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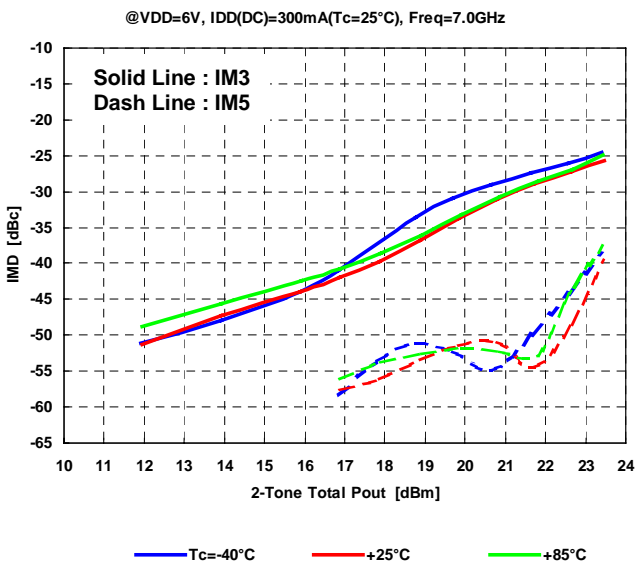
IMD vs. Output Power by Temperature



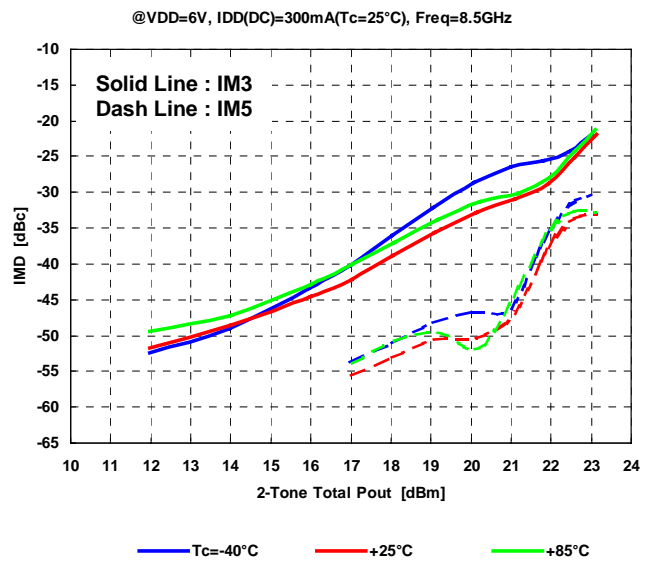
IMD vs. Output Power by Temperature



IMD vs. Output Power by Temperature



IMD vs. Output Power by Temperature

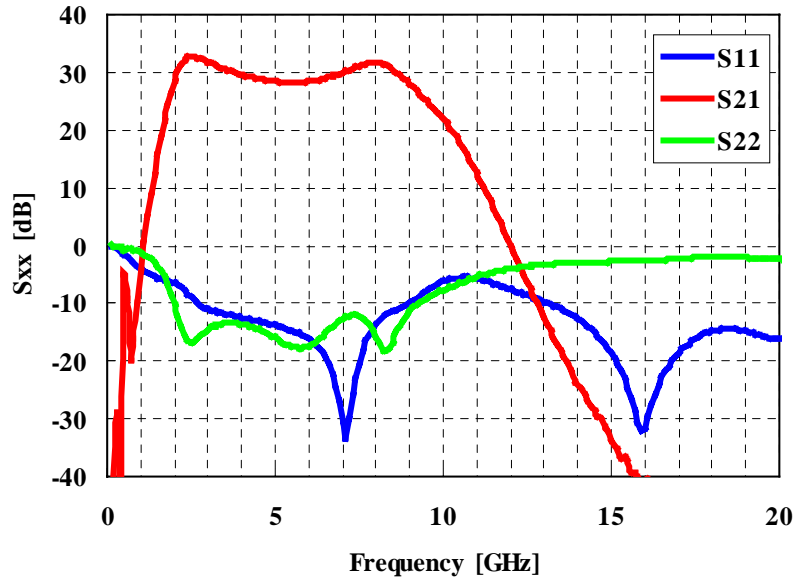


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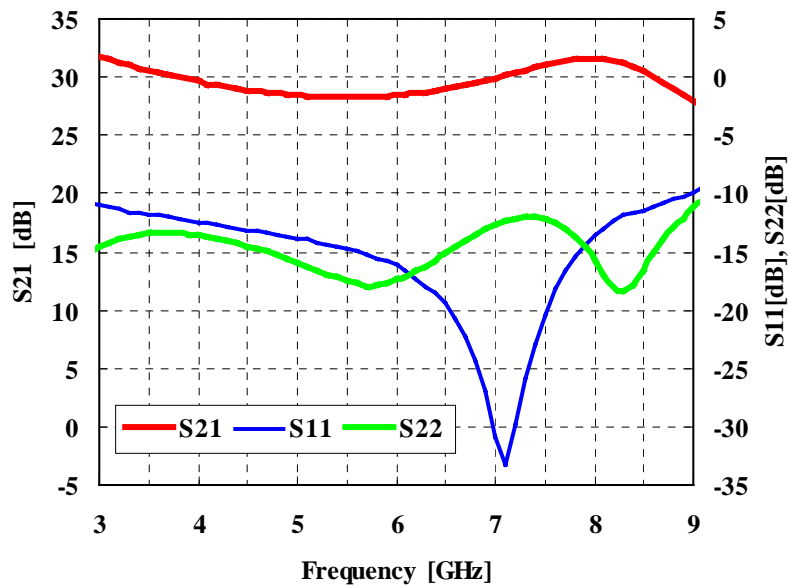
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■ S-Parameter

VDD/IDD(DC)=6V/300mA



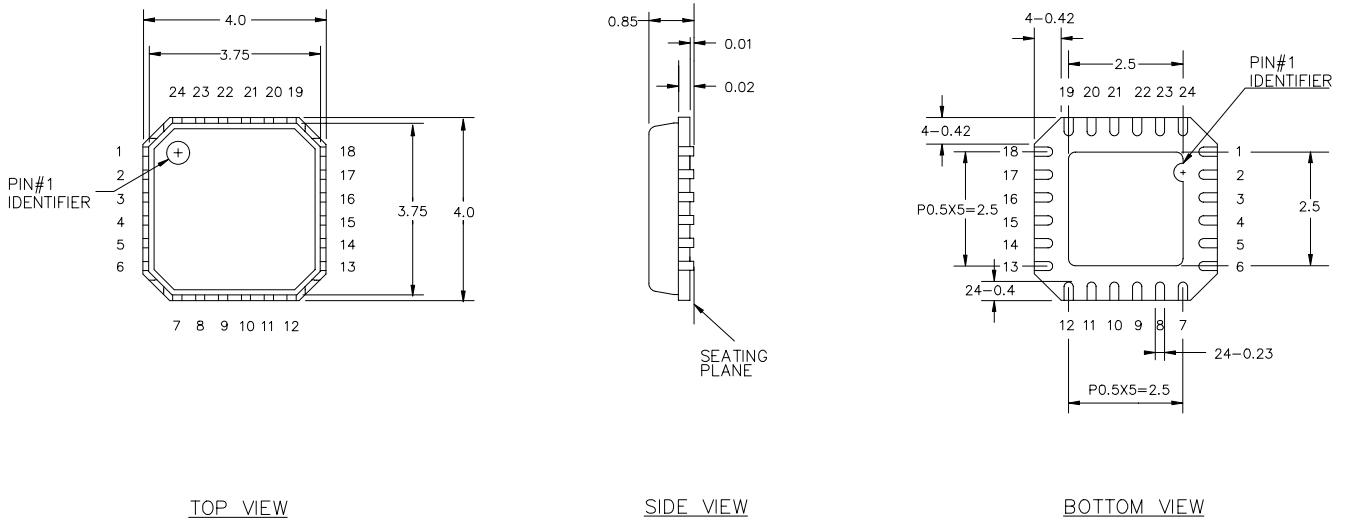
VDD/IDD(DC)=6V/300mA



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■ Package Outline and Pin Assignment



Unit : mm

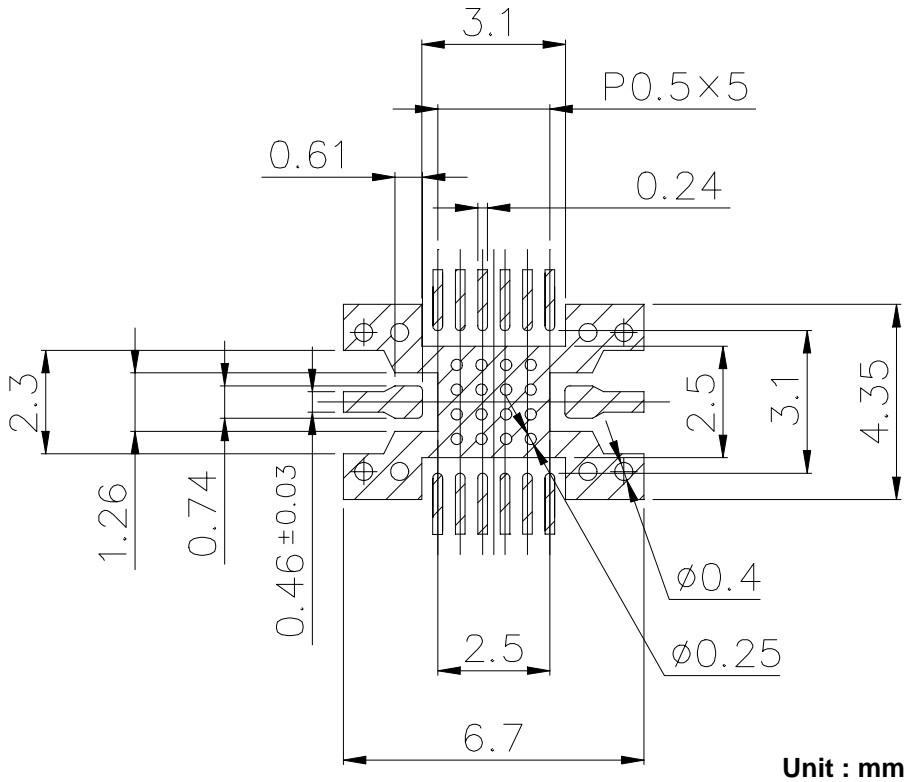
PIN Assignment

RF IN : 3,4
RF OUT : 15,16
VGG1 : 24 **VDD1 : 7**
VGG2 : 22 **VDD2 : 9**
VGG3 : 20 **VDD3 : 11**
N/C : 1,2,5,6,8,10,12,13,14,17,18,19,21,23

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■ PCB Pads and Solder-resist Pattern

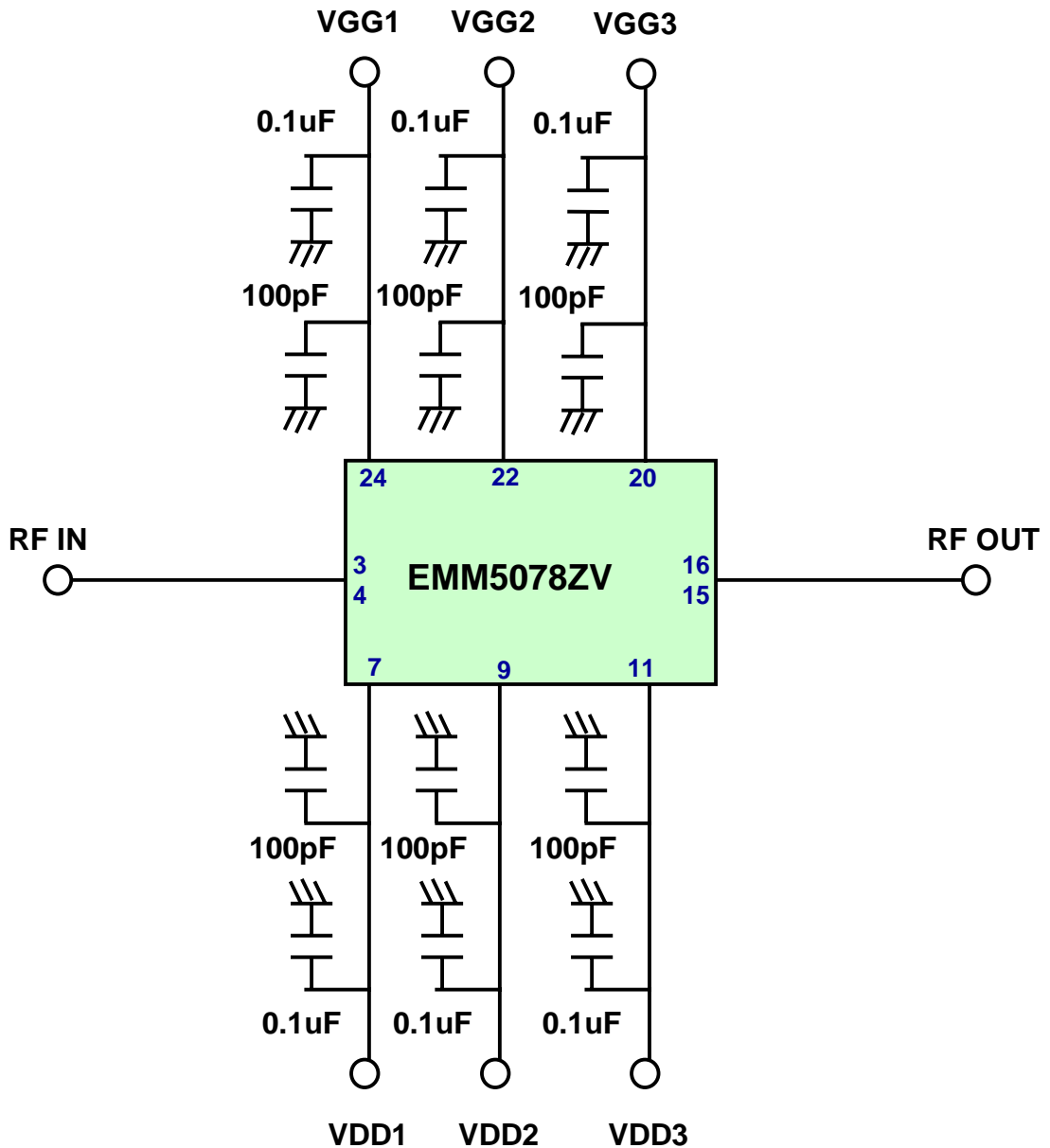


Notes :

- 1.LAMINATE : Rogers Corporation RO4003, Thickness $t=0.2\text{mm}$, Cu Foil $18\mu\text{m}$
Finish to copper foil ; Ni $0.1\mu\text{m min.}$ /Au $0.1\pm 0.08\mu\text{m}$ (Both side)

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■ Recommended Bias Network



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■ Mounting Method of SMD(Surface Mount Devices) for Lead-free Solder

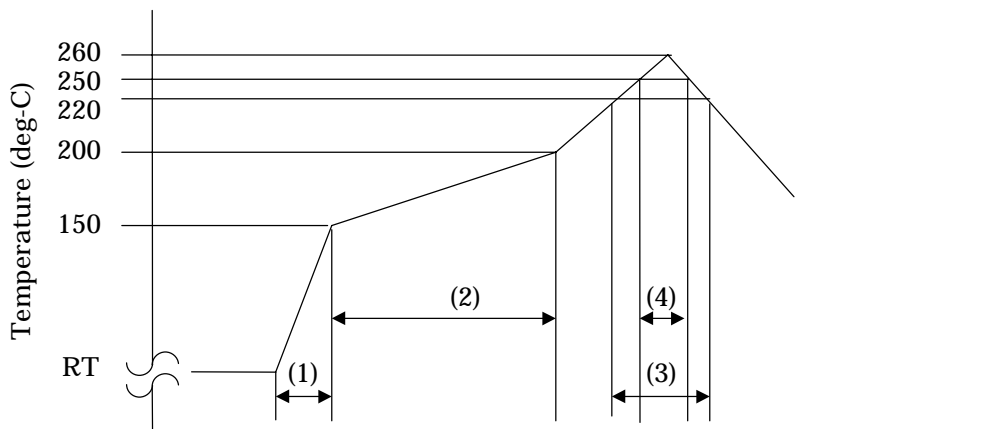
Mounting Condition

1. For soldering, Lead-free solder (Sn-3.0Ag-0.5Cu)*¹ or equivalent shall be used.
(*1:The figure displays with weight %. A predominantly tin-rich alloy with 3.0% silver and 0.5% copper.)
2. A rosin type flux with a chlorine content of 0.2% or less shall be used. The rosin flux with low halogen content is recommended.
3. When soldering, use one of the following time/ temperature methods for acceptable solder joints. Make sure the devices have been properly prepared with flux prior soldering.

* Reflow soldering method (Infrared reflow / Heat circulation reflow / Hot plate reflow):

Limit solder to 3 reflow cycles because resin is used in the modules manufacturing process. Excessive reflow cycles will effect the resin resulting in a potential failure or latent defect. The recommended reflow temperature profile is shown below. The temperature of the reflow profile must be measured at the device lead.

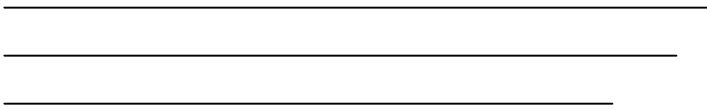
Reflow temperature profile and condition:



		Time
(1) Average Ramp-up Rate:	3 deg-C/seconds	
(2) Preheating:	150 - 200 deg-C,	60 - 180 seconds
(3) Main heating:	220 deg-C,	60 seconds max.
(4) Peak Temperature:	260 deg-C max., more than 250 deg-C,	10 seconds max.

* Measurement point: Device lead.

4. The above-recommended conditions were confirmed using the manufacture's equipment and materials. However, when soldering these products, the soldering condition should be verified by customer using their equipment and materials.



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C-Band Power Amplifier MMIC

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- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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